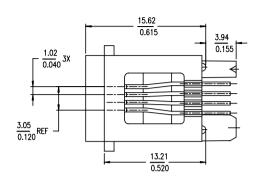
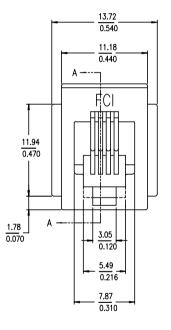
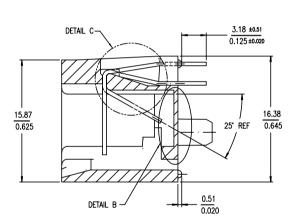
1 |

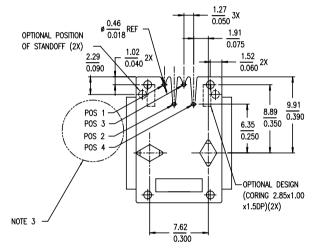
2



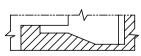






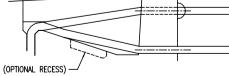


SECTION A-A





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DETAIL C

mat'l. code							sur			/			projectionproduct family											L	
							ISE1302 V ISE1101 ISE406 tolerances unless other							2.C	1	MOD JACK									
ltr	ecr	n no	þdr	2	tole	rano	es	unle	ss o	ther	wise	Spe	⊂lfie	atitl	e										
N	S90	S90142 JSR 10/4/'99   N05-0002 YS 01/06/05		"99	000	ر م		0.X	±0.3		mm			4 POS VERTICAL											
Ρ	N05-			/05	ung	<u>ק</u> רי		0.XX±0.15																	
R	R N08-0170 SH MM0 10/10/08				/08	0°±2	: :	0.XXX±0.05				sco	ile2	.0		P.C.B. MOD JACK ASSY									
S	S N09-0092 SH M40 05/25/09 T ELX-N-01070 SH M40 03/14/13		/09	dr CLFENG			02/21/97				dwg no					sheetlof2 s			siz	ŧ					
Т			sh waa	03/14/12		eng	r tol	VY CHIEN		HIEN 02/2			C	, i	69253					L					
							chr	TO	NY I	CHIEN	EN 02/2		, ' ¥		1		692			200				A4	·
							app	d JE	NN	TSAO	02/:	21/97		~	/	typ	e	Pro	duct	Cu	stom	ner	Draw	ing	
she	et	re۱	visio	nT		T																			
ind	ex	she	eet	1		2																			
											2													4	-
								F	PD9	S: Re	3 v : T				STA	TUS	:Re	leas	ed		Pri	ntec	:	Aı	4 Apr 20

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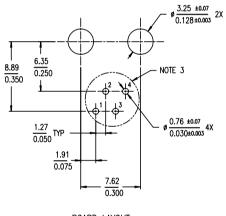
PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	HOUSING COLOR	NOTES	
69253-001 -001LF -011LF	ALL	5u" Au + high performance lubricant	BLACK	-	
-002 -002LF -012LF	ALL	5u" Au + high performance lubricant	BLACK	-	
-003 -003LF -013LF	ALL	5u" Au + high performance lubricant	BLACK	NOTE 1	
-004 -004LF -014LF	ALL	50u" /1,27u GXT	BLACK	-	
-005 -0051 -0151	ALL	5u" Au + high performance lubricant	GREY	-	
-006 -006LF -016LF	ALL	15u" GXT	BLACK	-	

LEAD FREE PRODUCT NO.

0: MEETS WAVE SOLDER PROCESS PRODUCT NO. 1: MEETS PIP PROCESS PRODUCT NO.

NOTE :

- (1)SPECIAL PACKAGING.
- 2 GXT IS 0,76um / 30u" OR 0,28um / 15u" MIN GXT WITH Au FLASH OVER 1,27um / 50u" MIN Ni.
- 3 THIS PIN NUMBERING IS OPPOSITE TO FCC, PART 68, SUBPART F REQUIRMENTS.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND 4 OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE 5 FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MINIMUM THICK CIRCUIT BOARD.
- IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION. 6
- $\bigcirc$ PLATING OPTIONS: MAY BE EITHER GOLD OR GXT PLATED AT MANUFACTURER'S OPTION.



BOARD LAYOUT VIEWED FROM TOP

mat	sur	fa	се	/ t	ole	era	nce	pro	projectionproduct family																	
		IS□1302 V   IS□1101 IS□							6_			MOD JACK														
ltr	ecn	nc	bdr		lte		tolerances unless ot							wise	Fspe	<del>_if</del> ie	dtitle									
N	S901-	42	JSR	10,	/4/	99	ang				0.X±0.3			mm			4 POS VERTICAL									
Р	N05-0	002	YS	6 01/06/05					Ľ	0.XX		(±0.15														
R	N08-0	170	sh mao	10/	/10/	<b>⁄08</b>	0°±:	2"   <sup>=</sup>	7	0.X	(XX:	±0.05	.05 scale2			.0	P.C.B. MOD JACK ASSY									
s	N09-0	092	sh mao	05/	/25/	/09	dr	C	ΣL	FENG	; 1	02/2	21/97				dwg	, na	2		5	shee	;t2	of2	siz	P
Т	ELX-N-O	010701 <mark>5H MM0</mark> 03/1		03/14/12		engrio		ONY CHIEN		EN 02/2		21/97	FCi			69253					A4					
							chr	т	DNY	CHIEP	N I	02/2	21/97			1		09200 A					A4			
							۵pp	d J	ENN	TSAC		02/2	21/97		~		typ	)e	Pro	duct	Cu	storr	ner	Draw	ing	В
she	et r	rev	/isio	n																						Б
ind	ex 🗄	she	et																							
	PDS: Rev :T 3 STAT										<b>ι</b> τυ	S:Re	leas	sed		Pri	nted	I: A	pr 2	0,4 <b>20</b>	12					

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